

# **SD1446**

# RF POWER BIPOLAR TRANSISTORS **UHF MOBILE APPLICATIONS**

#### **FEATURES SUMMARY**

- 50 MHz
- 12.5 VOLTS
- EFFICIENCY 55%
- COMMON EMITTER
- GOLD METALLIZATION
- P<sub>OUT</sub> = 70 W MIN. WITH 10 dB GAIN

#### **DESCRIPTION**

The SD1446 is a 12.5 V Class C epitaxial silicon NPN planar transistor designed primarily for land mobile transmitter applications. This device utilizes emitter ballasting and is extremely stable and capable of withstanding high VSWR under operat-Obsolete Product(s) ing conditions.

#### Figure 1. Package

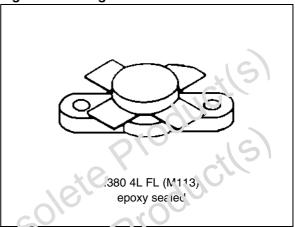
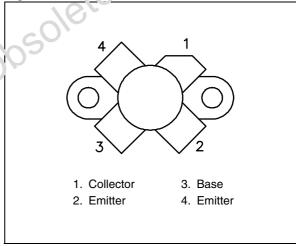


Figure 2. Pir Connection



Order Codes	Marking	Package	Packaging
SD1446	SD1446	M113	PLASTIC TRAYS

REV. 2

May 2004 1/7

Table 2. Absolute Maximum Ratings (T<sub>case</sub> = 25°C)

Symbol	Parameter	Value	Unit
V <sub>CBO</sub>	Collector-Base Voltage	36	V
V <sub>CEO</sub>	Collector-Emitter Voltage	18	V
V <sub>EBO</sub>	Emitter-Base Voltage	3.5	V
Ic	Device Current	12.0	Α
P <sub>DISS</sub>	Power Dissipation	183	W
TJ	Junction Temperature	+200	°C
T <sub>STG</sub>	Storage Temperature	- 65 to +150	°C

### **Table 3. Thermal Data**

Symbol	Parameter	Value	Unit
R <sub>TH(j-c)</sub>	Junction-Case Thermal Resistance	1 05	°C/W

## **ELECTRICAL SPECIFICATIONS (TCASE = 25°C)**

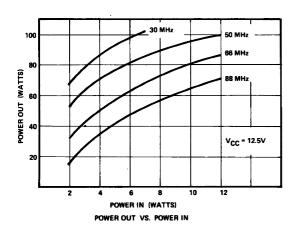
#### **Table 4. Static**

T <sub>STG</sub>	Storage Temperature	-	- 65 to +150		°C
Table 3. Therr	nal Data				51
Symbol	Parameter		Value	1010	Unit
R <sub>TH(j-c)</sub>	Junction-Case Thermal Resistance		1 05	<i>)</i>	°C/W
ELECTRICAL Table 4. Static	SPECIFICATIONS (T <sub>CASE</sub> = 25°C)	ejte	2,0 <sub>0</sub>	JUCIL	21
			Value		
Symbol	Test Conditions	Min.	Тур.	Max.	Unit
BV <sub>CBO</sub>	I <sub>C</sub> = 50 mA; I <sub>E</sub> = 0 mA	36	_	_	V
BV <sub>CES</sub>	I <sub>C</sub> = 100 mA; V <sub>BE</sub> = 0 $\vec{v}$	36	_	_	V
BV <sub>CEO</sub>	I <sub>C</sub> = 50 mA; I <sub>B</sub> = 6 m \	18	_	_	V
BV <sub>EBO</sub>	$I_E = 10 \text{ n/A} \cdot I_C = 0 \text{ mA}$	3.5	_	_	V
I <sub>CES</sub>	V <sub>CE</sub> = 15 V; I <sub>E</sub> = 0 mA	_	_	10	mA
h <sub>FE</sub>	ν <sub>CE</sub> = 5 V; I <sub>C</sub> = 5 A	10		_	_

Table 5. Dynamic						
Symbol	Value			Unit		
Symbol	Test Conditions	Min.	Тур.	Max.	Oilit	
Роит	f = 50 MHz; P <sub>IN</sub> = 7 W; V <sub>CE</sub> = 12.5 V	70	_	_	W	
GP	f = 50 MHz; P <sub>IN</sub> = 7 W; V <sub>CE</sub> = 12.5 V	10	_	_	dB	
ης	f = 50 MHz; P <sub>IN</sub> = 7 W; V <sub>CE</sub> = 12.5 V	_	55	_	%	
C <sub>OB</sub>	f = 1 MHz; V <sub>CB</sub> = 12.5 V	_	_	300	pF	

#### **TYPICAL PERFORMANCE**

Figure 3. Power Output vs Power Input



### **IMPEDANCE DATA**

Figure 4. Typical Input Impedance

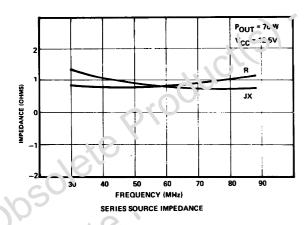


Figure 5. Typical Collector Load Impedance

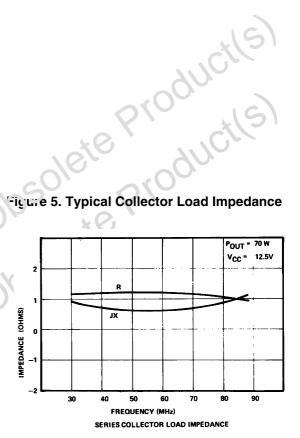


Table 6. Impedance Data (1)

X	FREQ.	<b>Z</b> <sub>IN</sub> (Ω)	<b>Z</b> <sub>CL</sub> (Ω)
	50 MHz	0.8 + j 0.9	1.2 + j 0.6

Note: 1.  $P_{OUT} = 70W$ ;  $V_{CE} = 12.5 V$ 

## **TEST CIRCUIT**

Figure 6. Test Circuit

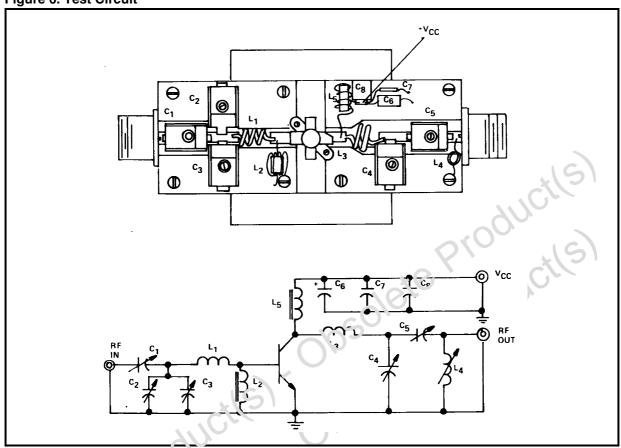


Table 7. Test Circ (it

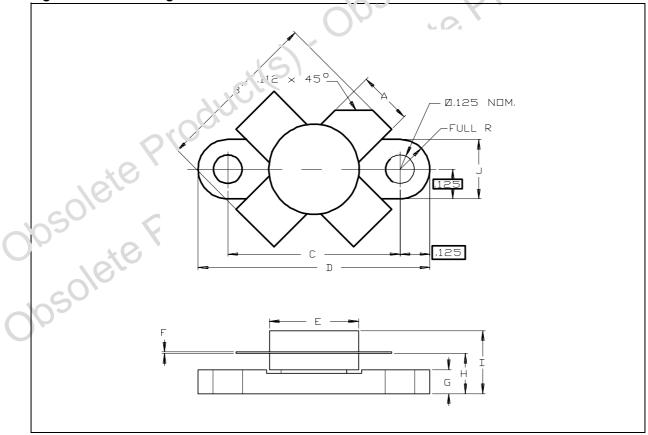
Table 11 Tool Gill Mile				
C1, C4	50 - 380pF Arco 465			
C2	110 - 580pF Arco 467			
C3	140 - 680pF Arco 468			
Ct	9 - 180pF Arco 463			
C6	10μF, 35Vdc, Electrolytic			
C7	.01μF Erie			
C8	1000pF Unelco			
L1 2 1/2 Turns, #14 Awg, Tinned, 1/4" I.D. Loose Wound				
L2	10 Turns, #28 AWG, Enameled on Ferroxcube Sleeve #3B			
L3	1 1/2 Turns, #12 AWG, Tinned, 3/8" I.D. Loose Wound			
L4	8 Turns, #18 AWG on 1/4" I.D. Coil form 1/2" Length with Ferrite Slug			
L5	11 Turns, #16 AWG, Enameled on Torroid, Micrometals, T50-2			
Board Material	Double Sided Copper 1/16" Thick			

### **PACKAGE MECHANICAL**

**Table 8. M113 Mechanical Data** 

Ol	millimeters			inches		
Symbol	Min	Тур	Max	Min	Тур	Max
Α	5.59		5.84	0.220		0.230
В	19.94			0.785		
С	18.29		18.54	0.720		0.730
D	24.64		24.89	0.970		0.980
E			9.78			r.385
F	0.10		0.15	0.004		€ 006
G	2.16		2.67	0.085	40	0.105
Н	4.06		4.57	0.160	100	0.180
I			7.11	T A		0.280
J	6.10		6.48	0.247	AU	0.255

Figure 7. M113 Package Dimensions



Note: Drawing is not to scale.

#### **REVISION HISTORY**

**Table 9. Revision History** 

Date	Revision	Description of Changes
November-1992	1	First Issue
25-May-2004	2	Stylesheet update. No content change.

Obsolete Product(s) Obsolete Product(s)
Obsolete Product(s)
Obsolete Product(s)

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47/